PATENT REEL: 010389 FRAME: 0975

	For x U.S. and/or x Foreign Rights
	For X Application or U.S. Patent
	By X Inventor(s) or Present Owner
ASSIGNMENT	Γ OF INVENTION
In consideration of the payment by ASSIGNE receipt of which is hereby acknowledged, and	EE to ASSIGNOR of the sum of One Dollar (\$1.00), the d for other good and valuable consideration,
ASSIGNOR:	
SUNCT JUN  Type or print name of ASSIGNOR	Type or print name of ASSIGNOR
BCK 210, #07-196, Bt. Batek ST.21 Address	BLK438 *03-483 Choa Chu Kong Ave 4
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Type or print name of ASSIGNOR	Ting Cheona Ang
Type or print name of ASSIGNOR	Ting Cheena Ang Type or print name of ASSIGNOR
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DILACAYSIAN	SINGAPOREAN
Nationality	Nationality
ASSIGNEE:	
Chartered Semiconductor Manufacturing 60 Woodlands Industrial Park D Street 2	Ltd.
Singapore 738406	
Singapore	
Nationality	
and the successors, assigns and legal repres	sentatives of the ASSIGNEE
(complete	one of the following)
x the entire right, title and interest	, , , , , , , , , , , , , , , , , , ,
an undivided percent (%)	interest for the United States and its territorial possessions
	gn rights are also to be assigned)
x and in all foreign countries	
in and to any and all improvements which are	e disclosed in the invention entitled:

**Novel Thick Oxide MOS Device Used In ESD Protection Circuit** 

PATENT REEL: 010389 FRAME: 0976

	For x	U.S. a	ınd/or	x For	eign Rights	
	For x	Applica	ation (	or 🔲 L	J.S. Patent	
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CHANG YUN GRANG	Type or prii	NG	PUM	124		
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SSIGNEE:						
Chartered Semiconductor Manufacturing	Ltd.					
60 Woodlands Industrial Park D	,					
Street 2						
Singapore 738406						
Singapore						
Nationality						
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x the entire right, title and interest			,			
an undivided percent (%)	interest fo	or the U	nited S	States ar	nd its territorial	possessions
(check the following box/f foreign						P
x and in all foreign countries						

A Method For Making Improved Shallow Trench Isolation For Semiconductor Integrated Circuits

in and to any and all improvements which are disclosed in the invention entitled:

PATENT REEL: 010389 FRAME: 0977

and which is found in	
(a) U.S. patent application executed on even	ı date herewith
(b) U.S. patent application executed on 101	11/99 10/4/99, 10/5/99, 10/11/99 & 10/12/99
	filed on
(d) U.S. patent no.	issued
[····]	oreign application(s) is also being assigned)
(e) and any legal equivalent thereof in a fore	ign country, including the right to clam priority
	for said invention by the above application or any and as to letters patent any re-issue or re-examination
ASSIGNOR hereby covenants that no assignments	ent, sale, agreement or encumbrance has been or will is assignment.
any and all papers, instruments or affidavits required	
If ASSIGNOR is a legal entity complete the following info	
	Type or print the name of the above person authorized to sign on behalf of ASSIGNOR
	Title
Note: No witnessing, notarization or legalization is necessary, if the as 261). Use next page if notarization is desired.	assignment is notarized or legalized then it will only be prima facie evidence (35 USC

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\_\_Notarization of Legalization Page Added.

U.S. patent application executed or	n 101 1.199, 1014 199, 1015199, 10111199 & 1011
	n 10/1/99, 10/4/99, 10/5/99, 10/1/99 E 10/1.
U.S. patent no.	issued (e) if foreign application(s) is also being assigned)
and any legal equivalent thereof in	a foreign country, including the right to clam priority
	tained for said invention by the above application or any ereof, and as to letters patent any re-issue or re-examination
ASSIGNOR hereby covenants that no as de or entered into which would conflict	signment, sale, agreement or encumbrance has been or will with this assignment.
8 KNOMU SUCI SCRESSIDIE IO VOCIPUOL SI	nd will testify as to the same in any interference, litigation or
id all papers, instruments or affidavits relation, said invention and said Letters Principle to carry out the purposes thereof TNESS WHEREOF, I / We have signed	
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\_\_Notarization of Legalization Page Added.

**RECORDED: 11/05/1999**